

SEK-19 SV MA STD ANG29 RLG 10PPLS4CLIP

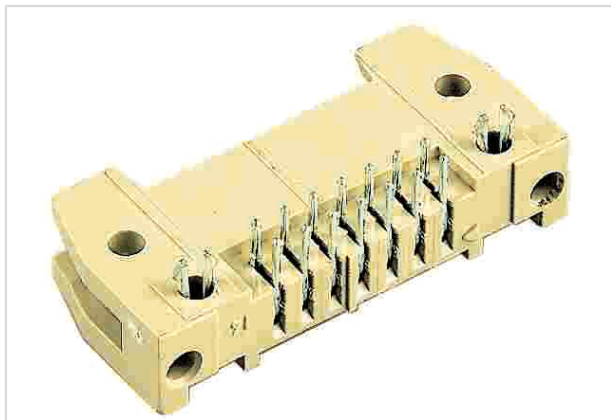


Image is for illustration purposes only. Please refer to product description.

Part number	09 19 510 5953
Specification	SEK-19 SV MA STD ANG29 RLG 10PPLS4CLIP
HARTING eCatalogue	https://b2b.harting.com/09195105953

Identification

Category	Connectors
Series	SEK Standard
Element	Male connector
Description of the contact	Angled

Version

Termination method	Reflow soldering termination (THR)
Locking type	With long levers
Connection type	PCB to cable
Number of contacts	10
Termination length	2.9 mm
PCB fixing	With board locks

Technical characteristics

Contact rows	2
Contact spacing (termination side)	2.54 mm
Rated current	1 A
Insulation resistance	$>10^9 \Omega$
Contact resistance	$\leq 20 \text{ m}\Omega$
Limiting temperature	-55 ... +125 °C (during reflow soldering max. +240 °C for 60 s)
Performance level	NM 30 (S4) 1
Test voltage $U_{r.m.s.}$	1 kV



Pushing Performance

Technical characteristics

Isolation group	II (400 ≤ CTI < 600)
PCB thickness	1.6 mm

Material properties

Material (insert)	Thermoplastic resin (PCT)
Colour (insert)	Beige
Material (contacts)	Copper alloy
Surface (contacts)	Sn over Ni Termination side Au over Pd/Ni Mating side
Material flammability class acc. to UL 94	V-0
RoHS	compliant
ELV status	compliant
China RoHS	e
REACH Annex XVII substances	No
REACH ANNEX XIV substances	No
REACH SVHC substances	No

Specifications and approvals

Specifications	IEC 60603-13
UL / CSA	UL 1977 ECBT2.E102079 CSA-C22.2 No. 182.3 ECBT8.E102079

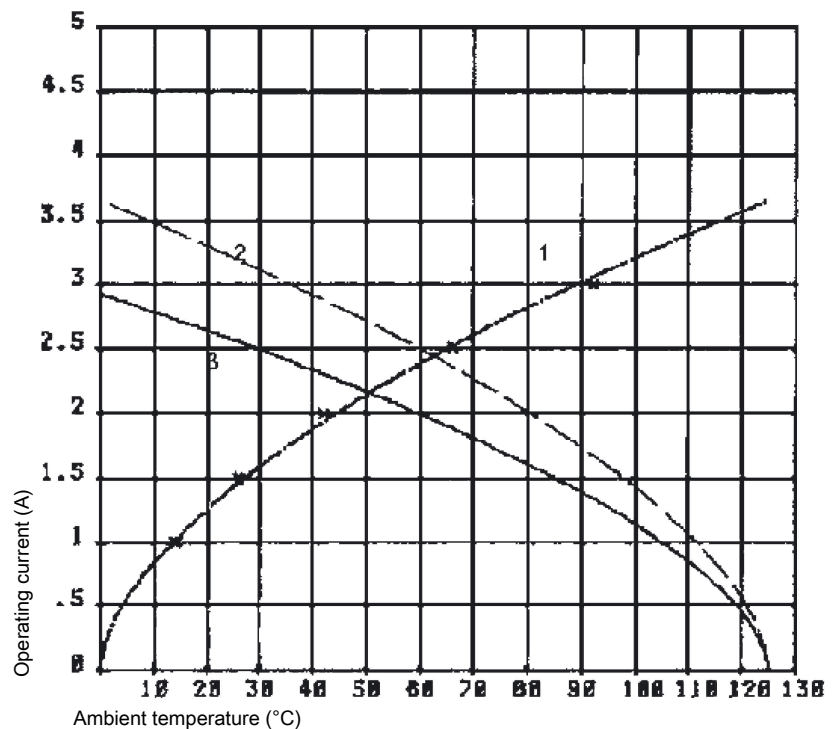
Commercial data

Packaging size	1
eCl@ss	27460201 PCB connector (board connector)

Current carrying capacity

The current carrying capacity of the connectors is limited by the thermal load capability of the contact element material including the connections and the insulating parts. The derating curve is therefore valid for currents which flow constantly (non-intermittent) through each contact element of the connector evenly, without exceeding the allowed maximum temperature.

Measuring and testing techniques acc. to IEC 60512-5-2



- ① Temperature raise
- ② Derating curve
- ③ Derating curve 80%

Cross section of solder termination

